

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

























High-temperature-resistant, 90° angled, open male header. Packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

### General ordering data

Version	PCB plug-in connector, male header, open side, THT/THR solder connection, 5.08 mm, Number of poles: 14, 90°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1780070000</u>
Туре	SL-SMT 5.08HC/14/90 3.2SN BK BX
GTIN (EAN)	4032248165391
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date March 25, 2021 6:52:32 AM CET



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Technical data**

### **Dimensions and weights**

Depth	12 mm	Depth (inches)	0.472 inch
Height	11.7 mm	Height (inches)	0.461 inch
Height of lowest version	8.5 mm	Net weight	5.87 g
Width	71.12 mm	Width (inches)	2.8 inch

### **System specifications**

Product family	OMNIMATE Signal - series BL/SL 5.08	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5.08 mm
Pitch in inches (P)	0.2 inch	Outgoing elbow	90°
Number of poles	14	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.5 mm
Solder eyelet hole diameter toler	rance (D)+ 0,1 mm	L1 in mm	66.04 mm
L1 in inches	2.6 inch	Number of rows	1
Pin series quantity	1	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	9 N
Pulling force/pole, max.	7 N		

### **Material data**

	LODOF		
Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt	-	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

### Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles	24 A
1 -7	19 A	(Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Technical data**

### Rated data acc. to CSA

nstitute (CSA)	<b>(SP</b> )	Certificate No. (CSA)	
			200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	18.5 A	Rated current (Use group D / CSA)	18.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059			
Institute (UR)	<b>57</b> 1.	Certificate No. (UR)	
	-		E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Packing			
Packaging	Box	VPE length	35 mm
VPE width	115 mm	VPE height	170 mm

Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

ETIM 6.0	EC002637	ETIM 7.0	EC002637	
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02	
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01	
Important note				
IPC conformity	standards and norms an	• •	vered according international recognized the data sheet resp. fulfill decorative properties roducts can be evaluated on request.	
Notes	Gold-plated contact si	urfaces on request		
	Rated current related to rated cross-section & min. No. of poles.			
	• Diameter of solder eyelet D = 1.4+0.1mm			
	Solder eyelet diamete	r D = 1.5 + 0.1 mm, from 9 poles		
	• P on drawing = pitch			
	•	to the component itself. Clearance and clance with the relevant application stand	creepage distances to other components are to dards.	
	Long term storage of	the product with average temperature o	f 50 °C and average humidity 70%, 36 months	



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Technical data**

### **Approvals**

Approvals



ROHS	Conform
UL File Number Search	E60693

### **Downloads**

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	STEP
Engineering Data	EPLAN, WSCAD



Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

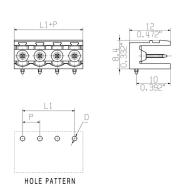
www.weidmueller.com

# **Drawings**

## **Product image**



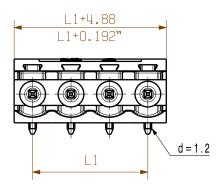
## **Dimensional drawing**

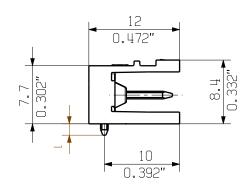


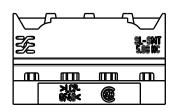
### **Product benefits**

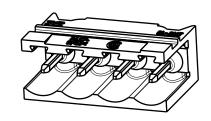


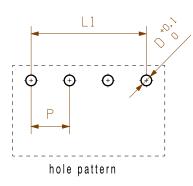
Safe power transmission Proven properties

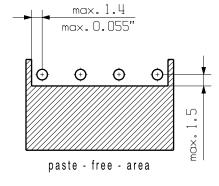












D = 1.4/0.055" or 1.5/0.059" (REFLOW SOLDERING) RECOMMENDATION FOR AUTOMATIC ASSEMBLY (1.4 mm FOR n = 2...8 / 1.5 mm for n = 9...24)

n = Polzahl / no of poles

P = Raster / pitch

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

alone.

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied

shown: SL-SMT 5.08HC/04/90

4.5	0.1/-0.3
3.2	0.1/-0.3
2.1	0.1/-0.3
1.5	-0.3
1	tolerance

16	76.20	3.000	
15	71.12	2.800	
14	66.04	2.600	+/- 0.15
13	60.96	2.400	
12	55.88	2.200	
11	50.80	2.000	
10	45.72	1.800	
9	40.64	1.600	
8	35.56	1.400	
7	30.48	1.200	
6	25.40	1.000	
5	20.32	0.800	+/- 0.1
4	15.24	0.600	
3	10.16	0.400	
2	5.08	0.200	
no of poles	L1 [mm]	L1 [inch]	tolerance L1

Cat.no.:.

33262

31

Issue no

sheets

24

23

22

21

20

19

18

17

116.84

111.76

106.68

101.60

96.52

91.44

86.36

81.28

4.600

4.400

4.200

4.000

3.800

3.600

3.400

3.200

+/-0.2

RoHS	DIN ISO 2768-m							
Rods		106339/4 30.07.18 HE	RTEL_S 0	W	e <i>idmü</i>	ller	<b>3</b> /2	
		Modification						
		Date	Name					
		Drawn	29.11.2007	HELIS_MA	SI	- S M T	5.08	
		Responsible		HERTEL_S	96	- O IVI I	STIFTLE	
Scale: 2:	1	Checked	01.08.2018	KOCH_JG			MALE HE	
Supersed	es:.	Approved		LANG_T	Product file:	SL-SMT	5.08	

HC/../90... ISTE

ADER

7280 Product file: SL-SMT 5.08

Drawing no.

Sheet 01



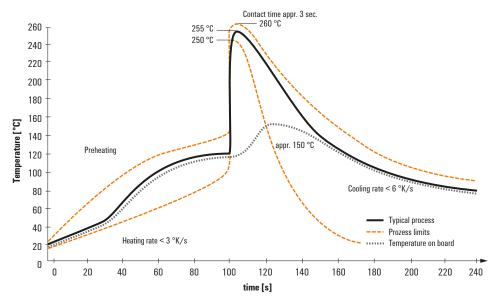
## Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

### Single Wave:



#### **Double Wave:**



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

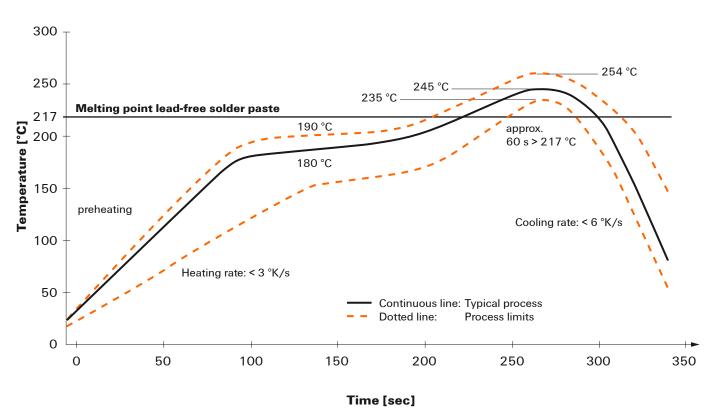


## Recommended reflow soldering profile

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com



### **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.